# **RENESAS** Platforms in Partnership with

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								Micron Ext	ernal Memor	у				
	Internal	NOF	NOR			N	AND					DRAM		
Product	er	Serial NOR, Xccela™	Parallel NOR	SLC NAND	e.MMC	UFS	SSD	µSD/SD	eUSB	LPDDR4/4X	DDR4	DDR3/3L	DDR2	SDR SDRAM
Family	s Controll	MT35X, MT25T, MT25Q	MT28EW, MT29FW	MT29F	MTFC	MTFC	MTFD	MTSD	MTED	MT53	MT40	MT41	MT47	MT48
Voltage	Embedded in Renesas Controller	1.8V, 3.3V	3.3V	1.8V, 3.3V	3.3V	3.3V	3.3V, 5V	-	3.3V, 5V	VDD1: 1.8V VDD2: 1.1V VDDQ: 1.1V/0.6V	1.2V	1.35V, 1.5V	1.8V	3.3V
Speed	bedded i	50–200 MHz SDR/DDR	Async 70– 105ns	ONFI 1.0/2.2	e.MMC 4.41, 4.51, 5.1	UFS 3.1	SATA 6 Gb/s PCle Gen 3	Class 10 (UHS-I U1)	USB 2.0, 3.1	3200- 4266 Mb/s	3200 Mb/s	1600-2133 Mb/s	800 Mb/s	133–167 MF
Width	Flash Emt	x4, x8	x8, x16	x1, x2, x4 (SPI) x8 x16 (Parallel)	-	_	-	-	-	x32	x8, x16	x8, x16	x8, x16	x8, x16, x32
Density		128Mb-2Gb	128Mb- 2Gb	1Gb- 256Gb	4GB-128GB	128GB- 256GB	>64GB	>8GB	2GB-32GB	4Gb-64Gb	8Gb-16Gb	1Gb-8Gb	512Mb-2Gb	64Mb- 256Mb
						System on	Chips (SOCs	) Aligned wit	h Micron Mer	mory				
R-Car S4	-	~			e.MMC 5.0	~	✔* (PCle)	<b>√</b> *		(3200 Mb/s, 32 bits)				
R-Car H3, M3, E3, H3e, H3Ne, M3e, M3Ne, E3e	_	v			e.MMC 5.0		(SATA)	r	v	H3: 3200 Mb/s, 128 bits M3: 3200 Mb/s, 64 bits		E3: 1866 Mb/s, 32 bits		
R-Car H2, M2, E2 R-Car V3U R-Car V3H2.	-	MT25T, MT25Q	<i>v</i> .	<b>*</b> *	e.MMC 4.41		H2, M2: SATA 2ch	V*	H2, M2: 4 ports, E2: 2 ports			✓ 1600 Mb/s, H2, M2: 32 bits x 2ch E2: 32 bits x 1ch		
R-Car V3U		2ch: MT25Q, 1ch: MT35X, MT25T			e.MMC 5.0					✓ 4266 Mb/s, 128 bits				
R-Car V3H2, V3H, V3M	-	2ch: MT25Q, 1ch: MT35X, MT25T			V3M: e.MMC 4.51, V3H: eMMC 5.0					V3H: 3200 Mb/s, 32 bits		V3M: 1600 Mb/s, 32 bits		
R-CAR V2H	-	MT25T, MT25Q	<i>v</i> .	×.	e.MMC 4.41			v.				1600 Mb/s, 32 bits x 1ch		
R-Car D3, D3e	-	2ch: MT25Q, 1ch: MT35X, MT25T		<b>v</b> *	~							1866 Mb/s, 16 bits x 1ch		
R-Car D1	-	~		×.	(e.MMC 4.41)				~			~		

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			External Memory														
		Internal	NOR	ł			N/	AND					DRAM				
	Product	er	Serial NOR, Xccela™	Parallel NOR	SLC NAND	e.MMC	UFS	SSD	µSD/SD	eUSB	LPDDR4/4X	DDR4	DDR3/3L	DDR2	SDR SDRAM		
	Family	Renesas Controller	MT35X, MT25T, MT25Q	MT28EW, MT29FW	MT29F	MTFC	MTFC	MTFD	MTSD	MTED	MT53	MT40	MT41	MT47	MT48		
Micron Memory	Voltage	50-20	1.8V, 3.3V	3.3V	1.8V, 3.3V	3.3V	3.3V	3.3V, 5V	-	3.3V, 5V	VDD1: 1.8V VDD2: 1.1V VDDQ: 1.1V/0.6V	1.2V	1.35V, 1.5V	1.8V	3.3V		
licron	Speed		50–200 MHz SDR/DDR	Async 70– 105ns	ONFI 1.0/2.2	e.MMC 4.41, 4.51, 5.1	UFS 3.1	SATA 6 Gb/s PCle Gen 3	Class 10 (UHS-I U1)	USB 2.0, 3.1	3200- 4266 Mb/s	3200 Mb/s	1600-2133 Mb/s	800 Mb/s	133-167 MHz		
2	Width	Flash Emi	x4, x8	x8, x16	x1, x2, x4 (SPI) x8 x16 (Parallel)	_	_	-	_	-	x32	x8, x16	x8, x16	x8, x16	x8, x16, x32		
	Density		128Mb-2Gb	128Mb- 2Gb	1Gb- 256Gb	4GB-128GB	128GB- 256GB	>64GB	>8GB	2GB-32GB	4Gb-64Gb	8Gb-16Gb	1Gb-8Gb	512Mb-2Gb	64Mb- 256Mb		
						Microc	controllers (M	MCUs) for Aut	tomotive Alig	gned with Mic	ron Memory						
Renesas Products	RH850/ D1Mx, D1Lx	5MB MAX (code) + 8KB (data)	D1L1: x4 SDR (40 MHz) D1L2: x4 SDR (120 MHz)/ DTR (80 MHz) D1Mx, D1L2H: x8 SDR (120 MHz)/ DTR (80 MHz)											✓ D1M2: 240 MHz, x16/ D1M2H: 240 MHz, x32	D1M1H: 80 MHz, x32		
	RH850/ U2A16	16MB max. (code) + 512KB (data)	act your local Micron			v.											

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									Externa	al Memory					
		Internal	NOF	1		NAND							DRAM		
	Product	ler	Serial NOR, Xccela™	Parallel NOR	SLC NAND	e.MMC	UFS	SSD	µSD/SD	eUSB	LPDDR4/4X	DDR4	DDR3/3L	DDR2	SDR SDRAM
	Family	s Controller	MT35X, MT25T, MT25Q	MT28EW, MT29FW	MT29F	MTFC	MTFC	MTFD	MTSD	MTED	MT53	MT40	MT41	MT47	MT48
Micron Memory	Voltage	Embedded in Renesas	1.8V, 3.3V	3.3V	1.8V, 3.3V	3.3V	3.3V	3.3V, 5V	-	3.3V, 5V	VDD1: 1.8V VDD2: 1.1V VDDQ: 1.1V/0.6V	1.2V	1.35V, 1.5V	1.8V	3.3V
licron	Speed	bedded	50–200 MHz SDR/DDR	Async 70– 105ns	ONFI 1.0/2.2	e.MMC 4.41, 4.51, 5.1	UFS 2.1, UFS 3.1	SATA 6 Gb/s	Class 10 (UHS-I U1)	USB 2.0, 3.1	3200- 4266 Mb/s	3200 Mb/s	1600-2133 Mb/s	800 Mb/s	133–167 MHz
2	Width	Flash Em	x4, x8	x8, x16	x1, x2, x4 (SPI) x8 x16 (Parallel)	-	-	-	-	-	x32	x8, x16	x8, x16	x8, x16	x8, x16, x32
	Density		128Mb-2Gb	128Mb- 2Gb	1Gb- 256Gb	2GB-128GB	32GB- 256GB	>64GB	>8GB	2GB-32GB	4Gb-64Gb	8Gb-16Gb	1Gb-8Gb	512Mb-2Gb	64Mb- 256Mb
	Microprocessors (MPUs) Aligned with Micron Memory														
	RZ/V2M, V2L	-	V2L: Xccela 100 MHz QSPI SDR/DDR 66/50 MHz			e.MMC 4.51			V*	v.	(V2M: 3200 Mb/s, x32 1ch)	(V2L: 1600 Mb/s, x16 1ch	(V2L: 1600 Mb/s, x16 1ch		
	RZ/A2M	-	Xccela: 132 MHz QSPI: x1, 55 MHz		<i>v</i> .	e.MMC 4.51			<i>~</i> .	~					<i>v</i> .
roducts	RZ/A1H, A1M, A1LU, A1LC, A1L	-	A1H, A1M: QSPI SDR 50 MHz, 1/2ch A1LU, A1L: QSPI SDR 66 MHz 1ch	~	v.	e.MMC 4.41			v.	~					r
Renesas Products	RZ/G2H, G2M, G2N, G2E	_	G2H,M,N: QSPI DDR 160 MHz MAX x4/x8 G2E: QSPI DDR 150/160 MHz MAX x4/x8			e.MMC 5.0, HS400		G2H, G2N: SATA Gen3	v.	~	✓* G2H: 3200 Mb/s x32 x 1ch G2M: 3200 Mb/s x32 x 2ch G2N: 3200 Mb/s x32 x 4ch		G2E: 1856 Mb/s x32 x 1ch		
*For	RZ/G2L, G2LC, G2UL	-	G2L: QSPI, 50 MHz DDR, 66 MHz SDR, 100 MHz X8 G2LC: QSPI, 50 MHz DDR/ 66MHz SDR, 1ch	sales represent	ative.	e.MMC 4.51			s.	v.		✔** 1600 Mb/e x16 x 1ch	₩* 1333 Mb/a x16 x 1ch		

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								Externa	I Memory					
	Internal	NOF	2			N	AND					DRAM		
Product	er	Serial NOR, Xccela™	Parallel NOR	SLC NAND	e.MMC	UFS	SSD	µSD/SD	eUSB	LPDDR4/4X	DDR4	DDR3/3L	DDR2	SDR SDRAM
Family	s Controll	MT35X, MT25T, MT25Q	MT28EW, MT29FW	MT29F	MTFC	MTFC	MTFD	MTSD	MTED	MT53	MT40	MT41	MT47	MT48
Voltage Speed	Embedded in Renesas Controller	1.8V, 3.3V	3.3V	1.8V, 3.3V	3.3V	3.3V	3.3V, 5V	-	3.3V, 5V	VDD1: 1.8V VDD2: 1.1V VDDQ: 1.1V/0.6V	1.2V	1.35V, 1.5V	1.8V	3.3V
Speed	pedded i	50–200 MHz SDR/DDR	Async 70– 105ns	ONFI 1.0/2.2	e.MMC 4.41, 4.51, 5.1	UFS 2.1, UFS 3.1	SATA 6 Gb/s	Class 10 (UHS-I U1)	USB 2.0, 3.1	3200- 4266 Mb/s	3200 Mb/s	1600-2133 Mb/s	800 Mb/s	133–167 MH
Width	Flash Emt	x4, x8	x8, x16	x1, x2, x4 (SPI) x8 x16 (Parallel)	-	-	-	-	-	x32	x8, x16	x8, x16	x8, x16	x8, x16, x32
Density		128Mb-2Gb	128Mb- 2Gb	1Gb- 256Gb	2GB-128GB	32GB- 256GB	>64GB	>8GB	2GB-32GB	4Gb-64Gb	8Gb-16Gb	1Gb-8Gb	512Mb-2Gb	64Mb- 256Mb
						Microproc	essors (MPUs	) Aligned wit	h Micron Me	mory				
RZ/G1H, G1M, G1N, G1E	_	OSPI SDR 48.75 MHz MAX, 1ch	v.		e.MMC 4.41		G1H, G1M, G1N: SATA Gen3	v.	v.			CDR3: CDR3: G1H: 1600Mb/s x32 x 2ch DDR3L: G1M: 1600Mb/s x32 x 1ch G1M: 1600Mb/s x32 x 2ch G1N: 1600Mb/s x32 x 1ch		
RZ/T1, T1-M	-	<i>V</i> *	s.						v.					✓* T1: 32-bit bus
RZ/T1, T1-M RZ/N1D, N1S, N1L	-	MT25Q		V*	~			~	V*			N1D only	<b>V</b> * N1D only	
						Microcontr	ollers (MCUs	) Aligned wit	th Micron Me	mory				
RX700, RX600	4MB MAX code + 64KB data	QSPI, SDR 60 MHz			e.MMC 4.51			~	V.					60 MHz MAX 80MHz for RX72M, x8/ x16/x32
RX200, RX100	1MB MAX code + 8KB MAX data						No external me	mory interface (ex	cept eUSB for RX	111/113/230/231)	1			
R-IN32M3, M4	-	x1/x2/x4, SDR, 50 MHz	r											

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		Internal	NOR	l			N/	AND					DRAM		
	Product	er	Serial NOR, Xccela™	Parallel NOR	SLC NAND	e.MMC	UFS	SSD	µSD/SD	eUSB	LPDDR4/4X	DDR4	DDR3/3L	DDR2	SDR SDRAM
	Family	s Controller	MT35X, MT25T, MT25Q	MT28EW, MT29FW	MT29F	MTFC	MTFC	MTFD	MTSD	MTED	MT53	MT40	MT41	MT47	MT48
Micron Memory	Voltage	Flash Embedded in Renesas	1.8V, 3.3V	3.3V	1.8V, 3.3V	3.3V	3.3V	3.3V, 5V	-	3.3V, 5V	VDD1: 1.8V VDD2: 1.1V VDDQ: 1.1V/0.6V	1.2V	1.35V, 1.5V	1.8V	3.3V
licron	Speed	pedded	50–200 MHz SDR/DDR	Async 70– 105ns	ONFI 1.0/2.2	e.MMC 4.41, 4.51, 5.1	UFS 2.1, UFS 3.1	SATA 6 Gb/s	Class 10 (UHS-I U1)	USB 2.0, 3.1	3200- 4266 Mb/s	3200 Mb/s	1600-2133 Mb/s	800 Mb/s	133-167 MHz
2	Width	Flash Eml	x4, x8	x8, x16	x1, x2, x4 (SPI) x8 x16 (Parallel)	-	_	-	-	-	x32	x8, x16	x8, x16	x8, x16	x8, x16, x32
	Density		128Mb-2Gb	128Mb- 2Gb	1Gb- 256Gb	2GB-128GB	32GB- 256GB	>64GB	>8GB	2GB-32GB	4Gb-64Gb	8Gb-16Gb	1Gb-8Gb	512Mb-2Gb	64Mb- 256Mb
							Microcontr	ollers (MCUs	) Aligned wit	th Micron Me	mory				
	S7G2	4MB + 64KB	QSPI			e.MMC 4.51			v*	<b>v</b> *					60/120 MHz
s	S5D3, S5D5, S5D9	2MB MAX code + 64KB MAX data	QSPI			e.MMC 4.51			v*	<i>~</i>					
Products	S3A1, S3A3, S3A6, S3A7	1MB MAX code + 16KB MAX data	QSPI			e.MMC 4.51			V*	V*					
Renesas F	S124, S128, S1JA	256KB MAX code + 8KB MAX data	QSPI							V*					
Re	RE01- 1500KB, RE01- 256K	1.5MB MAX code	QSPI							<b>✓*</b> 1500KB					
	RA2, RA4, RA6, RA8	1MB MAX code + 64KB MAX data	QSPI/Xccela			✔* RA6: eMMC 4.51			<b>V</b> *	V*					

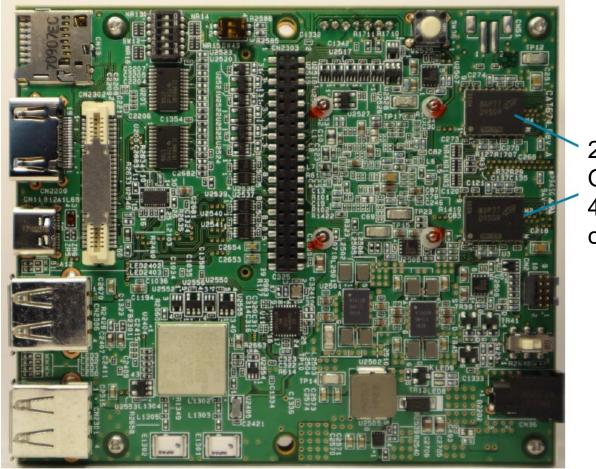
\*For additional details, please contact your local Micron sales representative.

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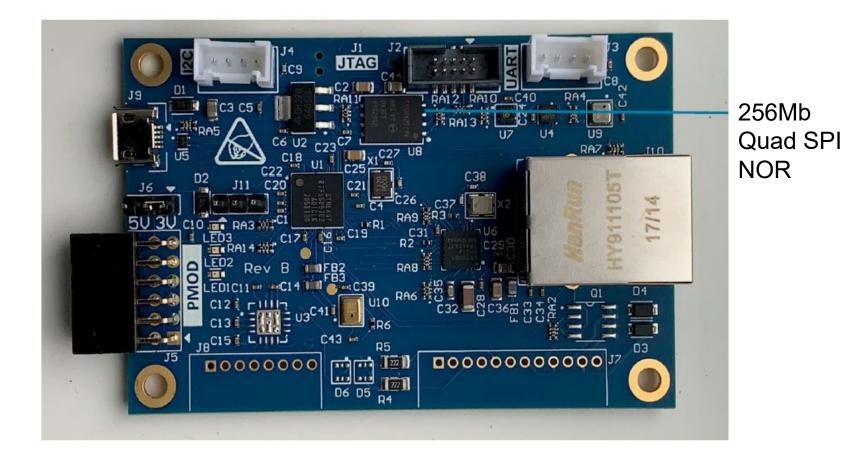
## **RZ/G2E Board – Top Side**



2GB total Qty 4 4Gb DDR3 components



# **Synergy AE-CLOUD1 Platform**



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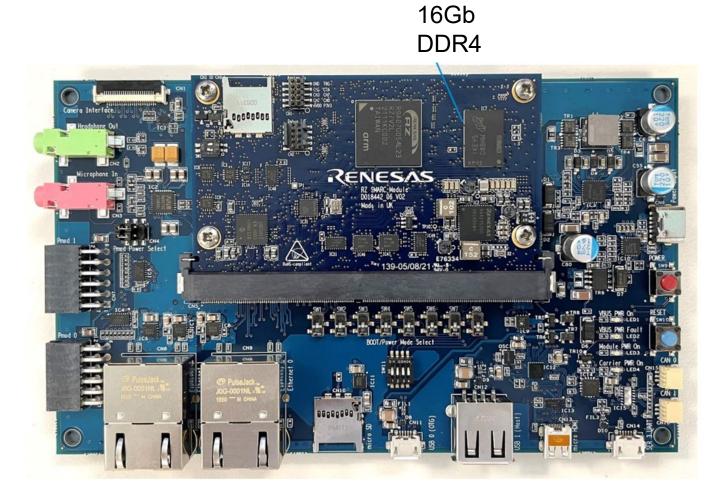
# **RZ/G2N Board**



LPDDR4

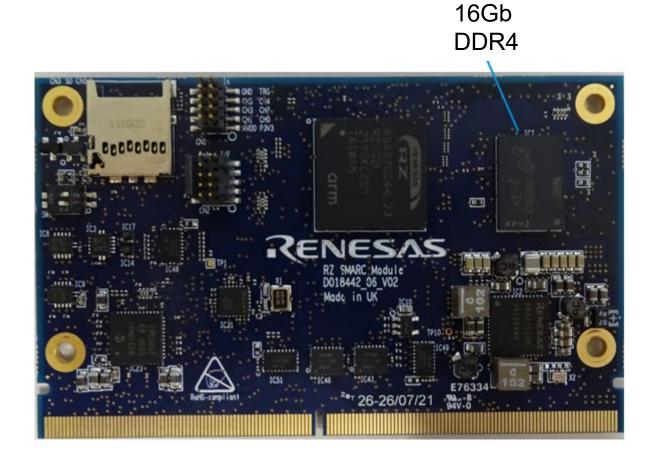
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# **RZ/V2L EVK. Board – Top Side**



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# **RZ/G2L Board – Top Side**





## **RZ/G2L Board – Bottom Side**





